Preferred Devices

# Surface Mount Ultrafast Power Rectifiers

Ideally suited for high voltage, high frequency rectification, or as free wheeling and protection diodes in surface mount applications where compact size and weight are critical to the system.

#### **Features**

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- High Temperature Glass Passivated Junction
- Low Forward Voltage Drop (0.71 V Max @ 1.0 A, T<sub>J</sub> = 150°C)
- Pb-Free Packages are Available

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 70 mg (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Polarity: Polarity Band Indicates Cathode Lead
- ESD Protection: Human Body Model > 4000 V (Class 3)

Machine Model > 400 V (Class C

#### **MAXIMUM RATINGS**

| Rating   | Symbol   | Value       | Unit |
|--|--|-------------|------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage MURA115T3 MURA120T3           | V <sub>RRM</sub><br>V <sub>RWM</sub><br>V <sub>R</sub> | 150<br>200  | V    |
| Average Rectified Forward Current  @ T <sub>L</sub> = 155°C  @ T <sub>L</sub> = 135°C                          | I <sub>F(AV)</sub>                                     | 1.0<br>2.0  | A    |
| Non-Repetitive Peak Surge Current<br>(Surge Applied at Rated Load Conditions<br>Halfwave, Single Phase, 60 Hz) | I <sub>FSM</sub>                                       | 40          | Α    |
| Operating Junction Temperature Range   | TJ   | -65 to +175 | °C   |

## THERMAL CHARACTERISTICS

| Characteristic   | Symbol  | Max       | Unit |
|--|---|-----------|------|
| Thermal Resistance, Junction–to–Lead (T <sub>L</sub> = 25°C) (Note 1) Thermal Resistance, Junction–to–Ambient (Note 1) | Psi <sub>JL</sub><br>(Note 2)<br>R <sub>θJA</sub> | 24<br>216 | °C/W |

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

- Rating applies when surface mounted on the minimum pad size recommended, PC Board FR-4.
- 2. In compliance with JEDEC 51, these values (historically represented by  $R_{\theta JL}$ ) are now referenced as  $Psi_{JL}$ .



## ON Semiconductor®

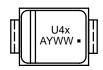
http://onsemi.com

## ULTRAFAST RECTIFIERS 1 AMPERE, 100-200 VOLTS



SMA CASE 403D PLASTIC

#### **MARKING DIAGRAM**



U4x = Device Code

x = C for MURA115T3 = D for MURA120T3

A = Assembly Location

Y = Year

WW = Work Week ■ Pb-Free Package

#### **ORDERING INFORMATION**

| Device     | Package          | Shipping <sup>†</sup> |
|------------|------------------|-----------------------|
| MURA115T3  | SMA              | 5000/Tape & Reel      |
| MURA115T3G | SMA<br>(Pb-Free) | 5000/Tape & Reel      |
| MURA120T3  | SMA              | 5000/Tape & Reel      |
| MURA120T3G | SMA<br>(Pb-Free) | 5000/Tape & Reel      |

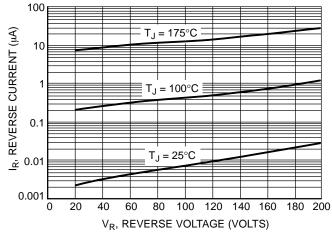
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Preferred devices are recommended choices for future use and best overall value

## **ELECTRICAL CHARACTERISTICS**

| Characteristic  | Symbol          | Max           | Unit |
|---|-----------------|---------------|------|
| Maximum Instantaneous Forward Voltage (Note 3)<br>( $i_F = 1.0 \text{ A}, T_J = 25^{\circ}\text{C}$ )<br>( $i_F = 1.0 \text{ A}, T_J = 150^{\circ}\text{C}$ ) | VF              | 0.875<br>0.71 | ٧    |
| Maximum Instantaneous Reverse Current (Note 3) (Rated DC Voltage, $T_J = 25^{\circ}C$ ) (Rated DC Voltage, $T_J = 150^{\circ}C$ )                             | İR              | 2.0<br>50     | μΑ   |
| Maximum Reverse Recovery Time (i <sub>F</sub> = 1.0 A, di/dt = 50 A/μs)   | t <sub>rr</sub> | 35            | ns   |

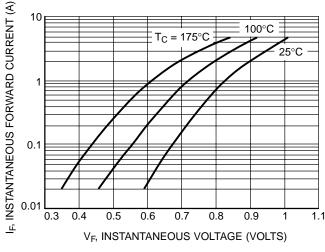
<sup>3.</sup> Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

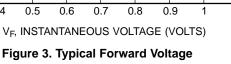


100  $T_J=175^{\circ}C$ IR, REVERSE CURRENT (µA) 10  $T_{.1} = 100^{\circ}C$  $T_J = 25^{\circ}C$ 0.1 20 100 120 140 160 180 200 V<sub>R</sub>, REVERSE VOLTAGE (VOLTS)

**Figure 1. Typical Reverse Current** 

Figure 2. Maximum Reverse Current





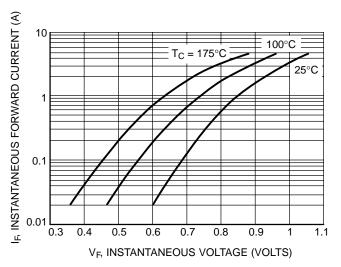


Figure 4. Maximum Forward Voltage

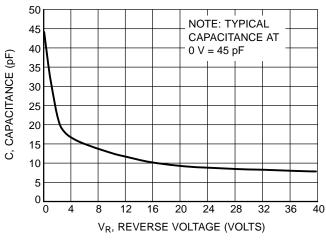


Figure 5. Typical Capacitance

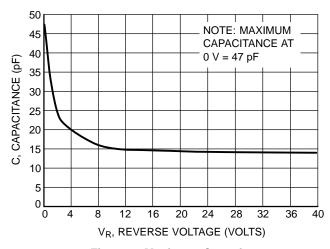


Figure 6. Maximum Capacitance

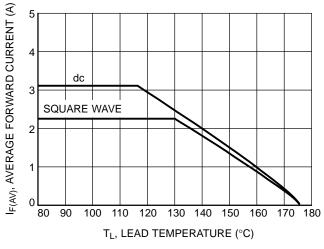


Figure 7. Current Derating, Lead

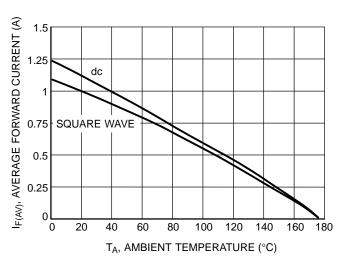


Figure 8. Current Derating, Ambient (FR-4 Board with Minimum Pad)

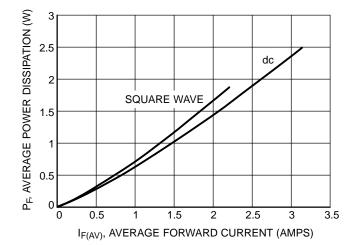
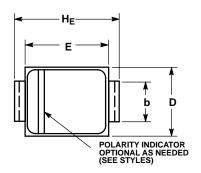


Figure 9. Power Dissipation

## PACKAGE DIMENSIONS

### **SMA** CASE 403D-02 **ISSUE C**



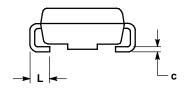
- NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

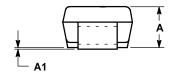
- 2. CONTROLLING DIMENSION: INCH.
  3. 403D-01 OBSOLETE, NEW STANDARD IS 403D-02.

|     | MILLIMETERS |      |      | INCHES |       |       |
|-----|-------------|------|------|--------|-------|-------|
| DIM | MIN         | NOM  | MAX  | MIN    | NOM   | MAX   |
| Α   | 1.91        | 2.16 | 2.41 | 0.075  | 0.085 | 0.095 |
| A1  | 0.05        | 0.10 | 0.15 | 0.002  | 0.004 | 0.006 |
| b   | 1.27        | 1.45 | 1.63 | 0.050  | 0.057 | 0.064 |
| С   | 0.15        | 0.28 | 0.41 | 0.006  | 0.011 | 0.016 |
| D   | 2.29        | 2.60 | 2.92 | 0.090  | 0.103 | 0.115 |
| E   | 4.06        | 4.32 | 4.57 | 0.160  | 0.170 | 0.180 |
| HE  | 4.83        | 5.21 | 5.59 | 0.190  | 0.205 | 0.220 |
| L   | 0.76        | 1.14 | 1.52 | 0.030  | 0.045 | 0.060 |

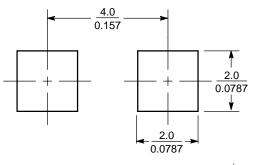
STYLE 1: PIN 1. CATHODE (POLARITY BAND)

2. ANODE





## **SOLDERING FOOTPRINT\***



 $\left(\frac{mm}{inches}\right)$ SCALE 8:1

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<sup>\*</sup>For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.